

## 500 mA, $\mu$ Cap Ultra-Low Dropout Regulator with High PSRR

### Features

- Ultra-Low Dropout Voltage: 200 mV @ 500 mA
- Input Voltage Range: 2.5V to 5.5V
- Output Voltage:
  - Adjustable:  $V_{REF} = 1.25V$
  - Fixed: 1.3V, 1.8V, 1.85V, 2.5V, 2.6V, 2.7V, 2.8V, 2.85V, 2.9V, 3.0V, 3.3V
- Stable with Low ESR Ceramic Output Capacitor
- Low Output Noise: 40  $\mu V_{RMS}$  (10 Hz to 100 kHz Bandwidth)
- Low Ground Current: 90  $\mu A$  Typical
- High PSRR, up to 70 dB @ 1 kHz
- Fast Turn-On Time: 40  $\mu s$  Typical
- High Output Accuracy:
  - $\pm 1.0\%$  Initial Accuracy
  - $\pm 2.0\%$  Over Temperature
- Thermal-Shutdown Protection
- Current-Limit Protection
- Logic-Controlled Enable Input Pin
- Available Packages:
  - 2 mm x 2 mm DFN, 500 mA Continuous
  - SOT23-5, 500 mA Peak

### General Description

The MIC5319 is a high performance, 500 mA LDO regulator, with high PSRR and very low noise, with low ground current.

Ideal for battery-operated applications, the MIC5319 features 1% accuracy, very low dropout voltage (typically 200 mV @ 500 mA), and low ground current at light load (typically 90  $\mu A$ ). Equipped with a logic-compatible enable pin, the MIC5319 can be set into a zero-off-mode current state, typically drawing only 0.5  $\mu A$  current when disabled.

The MIC5319 is a  $\mu$ Cap design operating with very small ceramic output capacitors for stability, thereby reducing required board space and component cost.

The MIC5319 is available in fixed-output voltages and adjustable output versions in the compact 2 mm x 2 mm DFN lead-less package or the thin SOT23-5 package.

### Applications

- Cellular Phones
- PDAs
- Fiber Optic Modules
- Portable Electronics
- Notebook PCs
- Audio Codec Power Supplies

### Package Types



# MIC5319

## Typical Application Circuit



## Functional Block Diagrams



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings †

Supply Input Voltage ( $V_{IN}$ ) .....	0V to +6V
Enable Input Voltage ( $V_{EN}$ ) .....	0V to +6V
Power Dissipation ( $P_D$ ) (Note 1) .....	Internally Limited
ESD Rating (Note 2) .....	3 kV, HBM

### Operating Ratings ‡

Supply Input Voltage ( $V_{IN}$ ) .....	+2.5V to +5.5V
Enable Input Voltage ( $V_{EN}$ ) .....	0V to $V_{IN}$

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

‡ **Notice:** The device is not guaranteed to function outside its operating ratings.

**Note 1:** The maximum allowable power dissipation of any  $T_A$  (ambient temperature) is  $P_{D(MAX)} = (T_{J(MAX)} - T_A)/\theta_{JA}$ . Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator may go into thermal shutdown.

**2:** Devices are ESD sensitive. Handling precautions recommended.

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**TABLE 1-1: ELECTRICAL CHARACTERISTICS**

**Electrical Characteristics:**  $V_{IN} = V_{OUT} + 1.0V$ ;  $C_{OUT} = 2.2 \mu F$ ;  $I_{OUT} = 100 \mu A$ ;  $T_A = +25^\circ C$ , **bold** values are available for the  $-40^\circ C$  to  $+125^\circ C$  junction temperature range, unless otherwise noted. (Note 1)

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
Output Voltage Accuracy	$\Delta V_{OUT}$	-1.0	—	1.0	%	Variation from nominal $V_{OUT}$
		<b>-2.0</b>	—	<b>2.0</b>		Variation from nominal $V_{OUT}$ , $I_{OUT} = 100 \mu A$ to 500 mA
Feedback Voltage (Adj. Option)	$V_{ADJ}$	1.2375	1.25	1.2625	V	—
		<b>1.225</b>	1.25	<b>1.275</b>		
Line Regulation	$\frac{\Delta V_{OUT}}{V_{OUT} \times \Delta V_{IN}}$	—	0.04	<b>0.3</b>	%/V	$V_{IN} = V_{OUT} + 1V$ to +5.5V
Load Regulation (Note 2)	$\frac{\Delta V_{OUT}}{V_{OUT}}$	—	0.1	<b>0.5</b>	%	$I_L = 100 \mu A$ to 500 mA
Dropout Voltage (Note 3, Note 4)	$V_{DO}$	—	20	<b>40</b>	mV	$I_{OUT} = 50$ mA
		—	200	<b>400</b>		$I_{OUT} = 500$ mA
Ground Pin Current (Note 5)	$I_{GND}$	—	90	<b>150</b>	$\mu A$	$I_{OUT} = 0$ mA to 500 mA
Ground Pin Current in Shutdown Mode	$I_{SHDN}$	—	0.5	—	$\mu A$	$V_{EN} \leq 0.2V$
Power Supply Ripple Rejection	PSRR	—	70	—	dB	f = up to 1 kHz; $C_{OUT} = 2.2 \mu F$ ceramic; $C_{BYP} = 0.1 \mu F$
		—	60	—	dB	f = 10 kHz; $C_{OUT} = 2.2 \mu F$ ceramic; $C_{BYP} = 0.1 \mu F$
Current Limit	$I_{LIMIT}$	<b>600</b>	700	—	mA	$V_{OUT} = 0V$
Output Voltage Noise	$e_N$	—	40	—	$\mu V_{RMS}$	$C_{OUT} = 2.2 \mu F$ ; $C_{BYP} = 0.1 \mu F$ ; 10 Hz to 100 kHz
Turn-On Time	$t_{ON}$	—	40	<b>100</b>	$\mu s$	$C_{OUT} = 2.2 \mu F$ ; $C_{BYP} = 0.1 \mu F$
Enable Input Voltage	$V_{ENABLE}$	—	—	<b>0.2</b>	V	Logic Low (Regulator Shutdown)
		<b>1.2</b>	—	—		Logic High (Regulator Enabled)
Enable Input Current	$I_{ENABLE}$	—	0.01	<b>1</b>	$\mu A$	$V_{IL} = \leq 0.2V$ (Regulator Shutdown)
		—	0.01	<b>1</b>		$V_{IH} = \geq 1.0V$ (Regulator Shutdown)

**Note 1:** Specification for packaged product only.

**2:** Regulation is measured at constant junction temperature using low duty cycle pulse testing.

**3:** Dropout voltage is defined as the input-to-output differential at which the output voltage drops 2% below its nominal  $V_{OUT}$ . For outputs below 2.5V, dropout voltage spec does not apply, as the part is limited by minimum  $V_{IN}$  spec of 2.5V. There may be some typical dropout degradation at  $V_{OUT} < 3V$ .

**4:** For Adjustable option,  $V_{OUT} = 3V$  for dropout specification.

**5:** Ground pin current is the regulator quiescent current. The total current drawn from the supply is the sum of the load current plus the ground pin current.

## TEMPERATURE SPECIFICATIONS (Note 1)

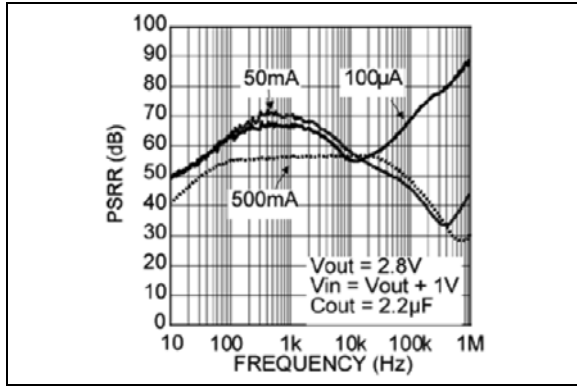
Parameters	Sym.	Min.	Typ.	Max.	Units	Conditions
<b>Temperature Ranges</b>						
Junction Operating Temperature Range	$T_J$	-40	—	+125	°C	—
Storage Temperature Range	$T_S$	-65	—	+150	°C	—
Lead Temperature	—	—	—	+260	°C	Soldering, 5s
<b>Package Thermal Resistances</b>						
Thermal Resistance DFN-6	$\theta_{JA}$	—	93	—	°C/W	—
Thermal Resistance Thin SOT23-5	$\theta_{JA}$	—	235	—	°C/W	—

**Note 1:** The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e.,  $T_A$ ,  $T_J$ ,  $\theta_{JA}$ ). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

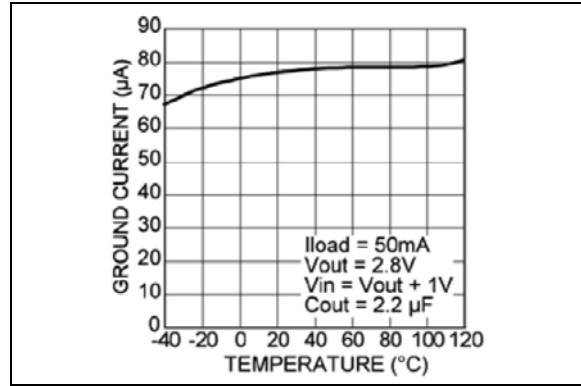
# MIC5319

## 2.0 TYPICAL PERFORMANCE CURVES

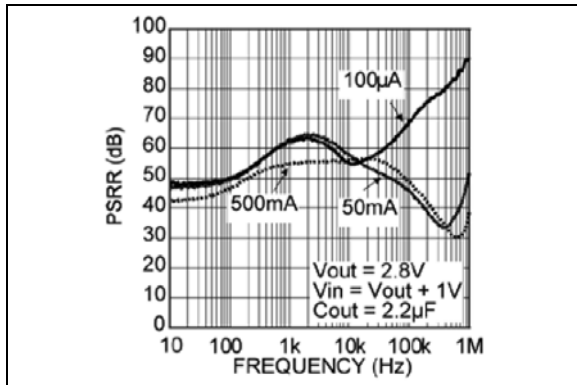
**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



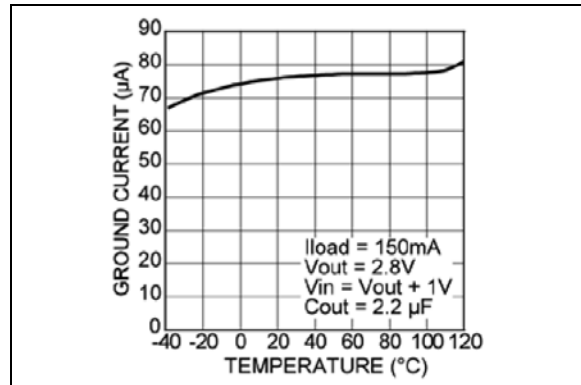
**FIGURE 2-1:** PSRR (Bypass Pin Capacitor =  $0.1 \mu F$ ).



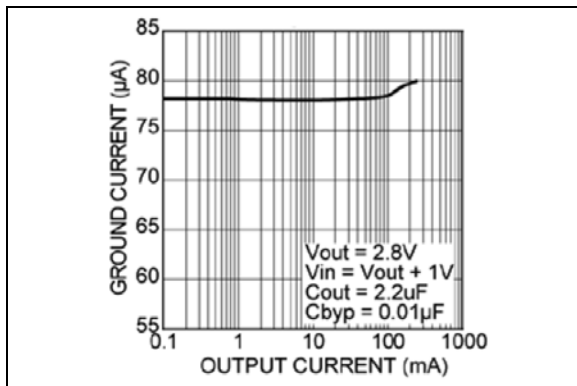
**FIGURE 2-4:** Ground Current vs. Temperature.



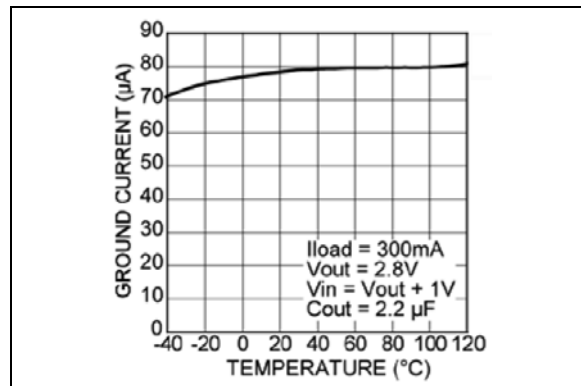
**FIGURE 2-2:** PSRR (Bypass Pin Capacitor =  $0.01 \mu F$ ).



**FIGURE 2-5:** Ground Current vs. Temperature.



**FIGURE 2-3:** Ground Current vs. Output Current.



**FIGURE 2-6:** Ground Current vs. Temperature.



**FIGURE 2-7:** Ground Current vs. Temperature.



**FIGURE 2-10:** Ground Current vs. Input Voltage.



**FIGURE 2-8:** Ground Current vs. Input Voltage.



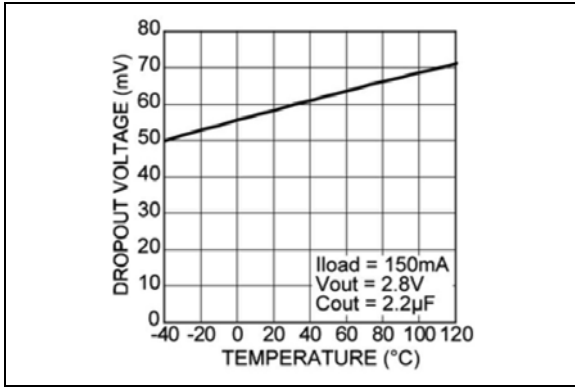
**FIGURE 2-11:** Dropout Characteristics.



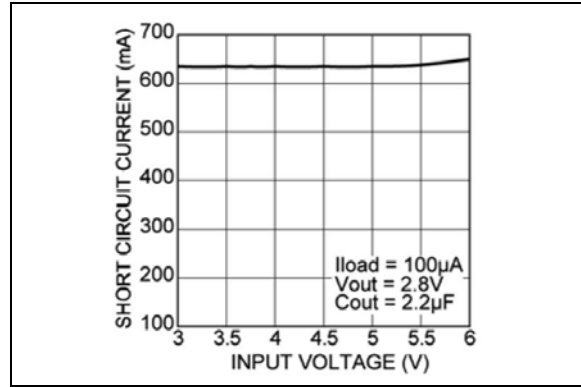
**FIGURE 2-9:** Ground Current vs. Input Voltage.



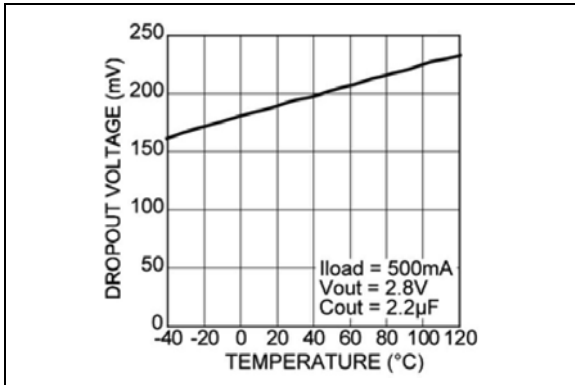
**FIGURE 2-12:** Dropout Voltage vs. Temperature.



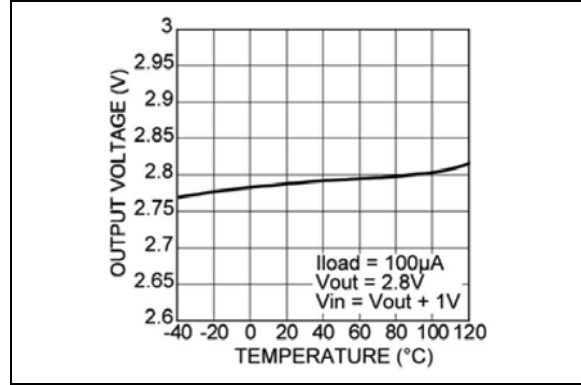
**FIGURE 2-13:** Dropout Voltage vs. Temperature.



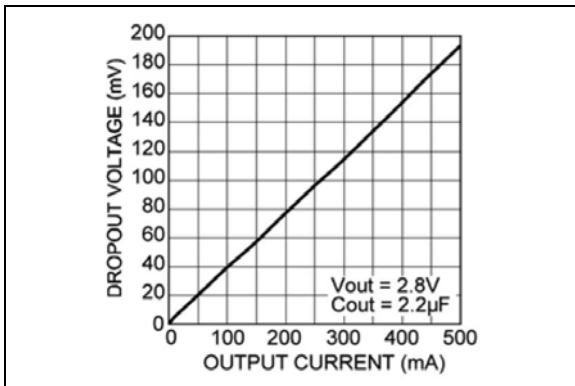
**FIGURE 2-16:** Short-Circuit Current vs. Input Voltage.



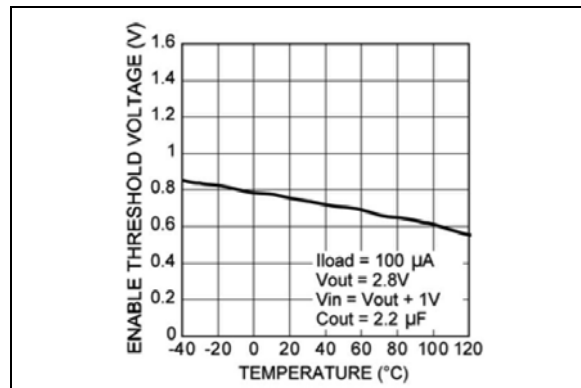
**FIGURE 2-14:** Dropout Voltage vs. Temperature.



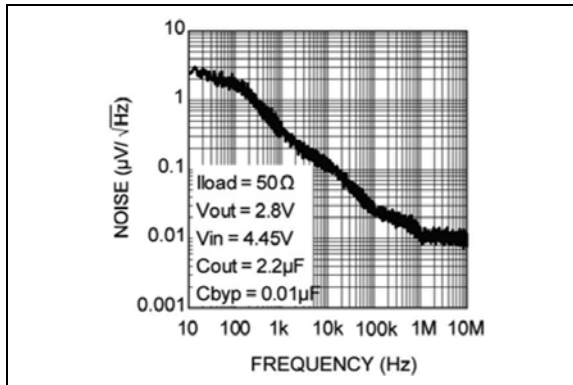
**FIGURE 2-17:** Output Voltage vs. Temperature.



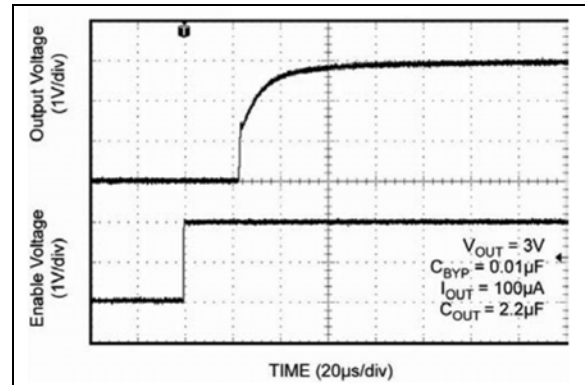
**FIGURE 2-15:** Dropout Voltage vs. Load Current.



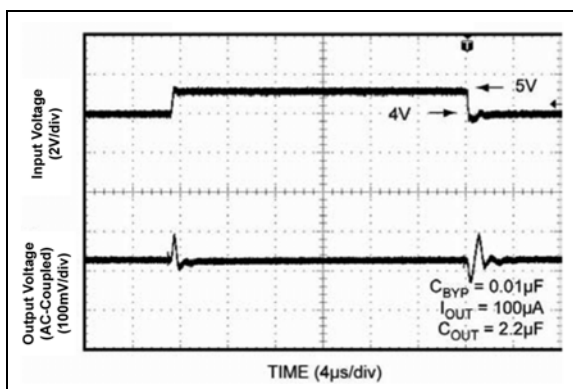
**FIGURE 2-18:** Enable Threshold vs. Temperature.



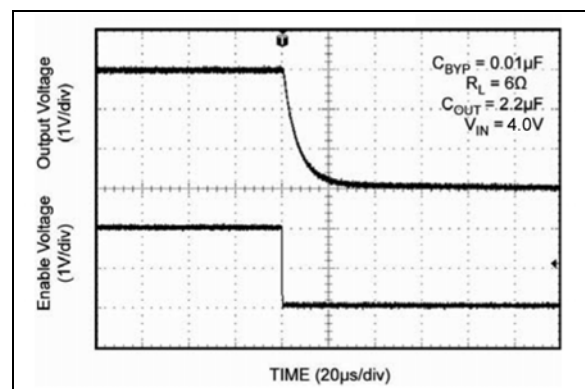
**FIGURE 2-19:** Output Noise Spectral Density.



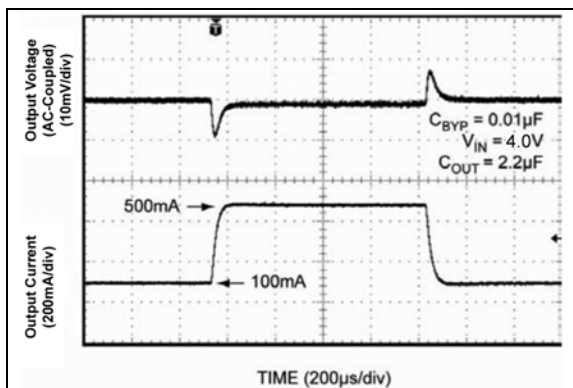
**FIGURE 2-22:** Enable Pin Delay (3.0V Fixed Output Version).



**FIGURE 2-20:** Line Transient Response (3.0V Fixed Output Version).



**FIGURE 2-23:** Shutdown Delay (3.0V Fixed Output Version).



**FIGURE 2-21:** Load Transient Response (3.0V Fixed Output Version).

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## 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in [Table 3-1](#).

**TABLE 3-1: PIN FUNCTION TABLE**

Pin Number DFN-6, Fixed	Pin Number DFN-6, Adj.	Pin Number SOT23-5	Pin Name	Description
1	1	3	EN	Enable Input: Active-High. High = Regulator ON, Low = Regulator OFF. Do not leave floating.
2	2	2	GND	Ground.
3	3	1	VIN	Input Voltage.
4	4	5	VOUT	Output Voltage.
—	5	—	ADJ	Adjustable Input: Connect to the external resistor voltage divider network to set the desired output voltage.
5	—	—	NC	Not connected for the DFN fixed output voltage version.
6	6	4	BYP	Reference Bypass: Connect external 0.1 $\mu$ F to GND for reduced output noise. May be left open.
EP	EP	—	EP	Exposed Pad connected to ground internally. Must be connected to the ground plane of the application board for optimal heat dissipation.

## 4.0 APPLICATION INFORMATION

### 4.1 Enable/Shutdown

The MIC5319 features an active-high enable pin that allows the regulator to be disabled. Forcing the enable pin low disables the regulator and sends it into a “zero” off-mode current state. In this state, the current consumed by the regulator is typically only 0.5  $\mu$ A. Forcing the enable pin high enables the output voltage. The active-high enable pin uses CMOS technology and the enable pin cannot be left floating, as this may cause an undetermined state on the output.

### 4.2 Input Capacitor

The MIC5319 is a high-performance, high bandwidth device. Therefore, it requires a well-bypassed input supply for optimal performance. A minimum 1  $\mu$ F capacitor is required from the input-to-ground to provide stability. Low-ESR ceramic capacitors provide optimal performance at a minimum of space. Additional high-frequency capacitors, such as small-valued NPO dielectric-type capacitors, help filter out high-frequency noise and are good design practice in any RF-based circuit.

### 4.3 Output Capacitor

The MIC5319 requires an output capacitor of 2.2  $\mu$ F or greater to maintain stability. The design is optimized for use with low-ESR ceramic chip capacitors. High ESR capacitors may cause high-frequency oscillation. The output capacitor can be increased, but performance has been optimized for a 2.2  $\mu$ F ceramic output capacitor and does not improve significantly with larger capacitance.

X7R/X5R dielectric-type ceramic capacitors are recommended because of their temperature performance. X7R-type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60%, respectively, over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric, the value must be much higher than an X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

### 4.4 Bypass Capacitor

A capacitor can be placed from the bypass pin-to-ground to reduce output voltage noise. The capacitor bypasses the internal reference. A 0.1  $\mu$ F capacitor is recommended for applications that require low-noise outputs. The bypass capacitor can be increased, further reducing noise and improving PSRR. Turn-on time increases slightly with respect to bypass capacitance.

A unique, quick-start circuit allows the MIC5319 to drive a large capacitor on the bypass pin without significantly slowing turn-on time.

### 4.5 No-Load Stability

Unlike many other voltage regulators, the MIC5319 will remain stable and in regulation with no load. This is especially important in CMOS RAM keep-alive applications.

### 4.6 Adjustable Regulator Application

Adjustable regulators use a two-resistor divider to multiply the reference voltage and to produce the desired output voltage.

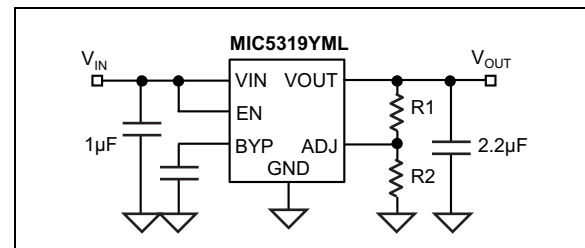
The MIC5319 output voltage can be adjusted from 1.25V to 5.5V by using two external resistors (Figure 4-1). The resistors set the output voltage based on the following equation:

#### EQUATION 4-1:

$$V_{OUT} = V_{REF} \left( 1 + \frac{R1}{R2} \right)$$

Where:

$$V_{REF} = 1.25V$$



**FIGURE 4-1:** Adjustable Voltage Typical Application.

### 4.7 Thermal Considerations

The MIC5319 is designed to provide 500 mA of continuous current in a very small DFN package. Maximum ambient operating temperature can be calculated based on the output current and the voltage drop across the part. Given an input voltage of 3.3V, output voltage of 2.8V, and output current of 500 mA, the actual power dissipation of the regulator circuit can be determined using the equation:

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## EQUATION 4-2:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND}$$

Because this device is CMOS and the ground current is typically <100  $\mu$ A over the load range, the power dissipation contributed by the ground current is <1% and can be ignored for this calculation:

## EQUATION 4-3:

$$P_D = (3.3V - 2.8V) \times 500mA = 0.25W$$

To determine the maximum ambient operating temperature of the package, use the junction-to-ambient thermal resistance of the device and the following basic equation:

## EQUATION 4-4:

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

Where:

$$T_{J(MAX)} = 125^\circ\text{C}$$

$$\theta_{JA} = 93^\circ\text{C/W (for the DFN package)}$$

Substituting 0.25W for  $P_{D(MAX)}$  and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit. The maximum power dissipation must not be exceeded for proper operation.

## EQUATION 4-5:

$$0.25W = \frac{125^\circ\text{C} - T_A}{93^\circ\text{C/W}}$$

$$T_A = 101.75^\circ\text{C}$$

Therefore, a 2.8V application at 500 mA of output current can accept an ambient operating temperature of 101.75°C in a 2 mm x 2 mm DFN package. For a full discussion of heat sinking and thermal effects on voltage regulators, refer to the “Regulator Thermals” section of Microchip’s [Designing with Low-Dropout Voltage Regulators](#) handbook.

## 5.0 PACKAGING INFORMATION

### 5.1 Package Marking Information

5-Pin TSOT23\*

XXXX  
NNN

6-Pin DFN\*

▲ XXX  
NNN

Part Number	Marking
MIC5319YML-TR	<u>9AA</u>
MIC5319-5.0YML-TR	<u>950</u>
MIC5319-5.0YD5-TR	<u>N950</u>
MIC5319-3.3YML-TR	<u>933</u>
MIC5319-3.3YD5-TR	<u>N933</u>
MIC5319-3.0YML-TR	<u>930</u>
MIC5319-3.0YD5-TR	<u>N930</u>
MIC5319-2.9YML-TR	<u>N929</u>
MIC5319-2.8YML-TR	<u>928</u>
MIC5319-2.8YD5-TR	<u>N928</u>
MIC5319-2.85YML-TR	<u>92J</u>
MIC5319-2.7YML-TR	<u>927</u>
MIC5319-2.7YD5-TR	<u>N927</u>
MIC5319-2.6YML-TR	<u>926</u>
MIC5319-2.6YD5-TX	<u>N926</u>
MIC5319-2.6YD5-TR	<u>N926</u>
MIC5319-2.5YML-TR	<u>925</u>
MIC5319-2.5YD5-TX	<u>N925</u>
MIC5319-2.5YD5-TR	<u>N925</u>
MIC5319-1.8YML-TR	<u>918</u>
MIC5319-1.8YD5-TX	<u>N918</u>
MIC5319-1.8YD5-TR	<u>N918</u>
MIC5319-1.85YML-TR	<u>91J</u>
MIC5319-1.85YD5-TX	<u>N91J</u>
MIC5319-1.85YD5-TR	<u>N91J</u>
MIC5319-1.3HYML-TR	<u>13H</u>
MIC5319-1.3HYD5-TR	<u>N13H</u>

Example

Z31J  
689

Example

▲ 933  
689

**Legend:** XX...X Product code or customer-specific information  
 Y Year code (last digit of calendar year)  
 YY Year code (last 2 digits of calendar year)  
 WW Week code (week of January 1 is week '01')  
 NNN Alphanumeric traceability code  
 (e3) Pb-free JEDEC® designator for Matte Tin (Sn)  
 \* This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.  
 ●, ▲, ▼ Pin one index is identified by a dot, delta up, or delta down (triangle mark).

**Note:** In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.  
 Underbar ( ) and/or Overbar ( ) symbol may not be to scale.

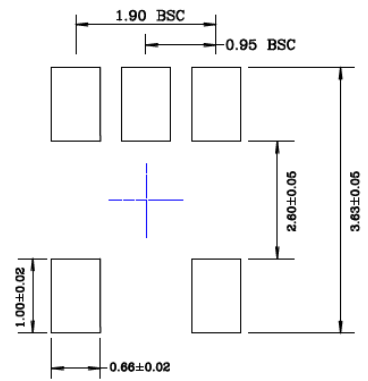
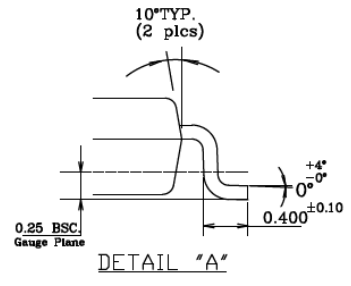
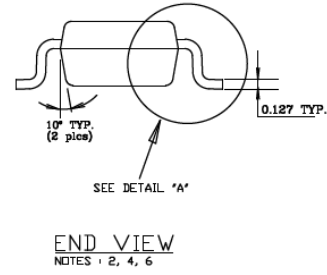
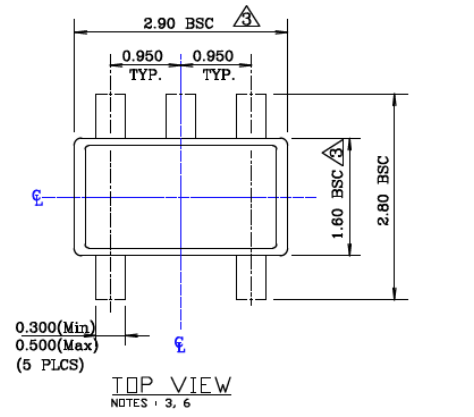
# MIC5319

## 5-Lead TSOT Package Outline and Recommended Land Pattern

**TITLE**

5 LEAD TSOT PACKAGE OUTLINE & RECOMMENDED LAND PATTERN

<b>DRAWING #</b>	TSOT-5LD-PL-1	<b>UNIT</b>	MM
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- NOTE:**
1. Dimensions and tolerances are as per ANSI Y14.5M, 1994.
  2. Die is facing up for mold. Die is facing down for trim/form, ie. reverse trim/form.
  3. Dimensions are exclusive of mold flash and gate burr.
  4. The footlength measuring is based on the gauge plane method.
  5. All specification comply to Jedec Spec MO193 Issue C.
  6. All dimensions are in millimeters.

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>.

## 6-Lead DFN 2 mm x 2 mm Package Outline and Recommended Land Pattern

**TITLE**

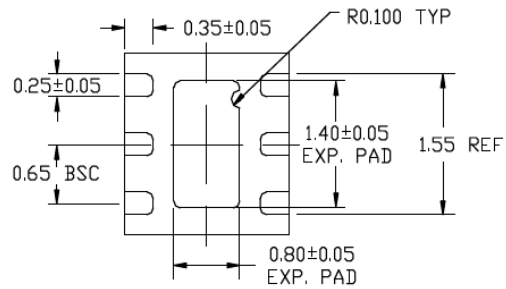
6 LEAD DFN 2x2mm PACKAGE OUTLINE & RECOMMENDED LAND PATTERN

DRAWING #	DFN22-6LD-PL-1	UNIT	MM
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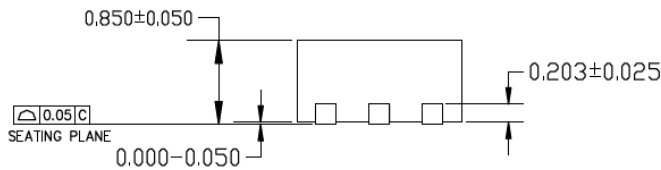
TOP VIEW

NOTE: 1, 2, 3



BOTTOM VIEW

NOTE: 1, 2, 3



END VIEW

NOTE: 1, 2, 3

**NOTE:**

1. MAX PACKAGE WARPAGE IS 0.05 MM
2. MAX ALLOWABLE BURR IS 0.076MM IN ALL DIRECTIONS
3. PIN #1 IS ON TOP WILL BE LASER MARKED
4. RED CIRCLE IN LAND PATTERN INDICATE THERMAL VIA. SIZE SHOULD BE 0.30-0.3M IN DIAMETER AND SHOULD BE CONNECTED TO GND FOR MAX THERMAL PERFORMANCE
5. GREEN RECTANGLES (SHADED AREA) indicate SOLDER STENCIL OPENING ON EXPOSED PAD AREA. SIZE SHOULD BE 0.60x0.40 MM IN SIZE, 0.20 MM SPACING.

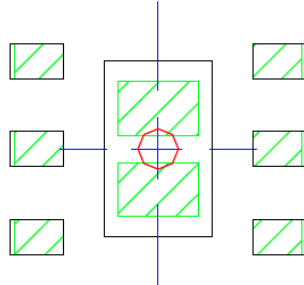
Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>.

# MIC5319

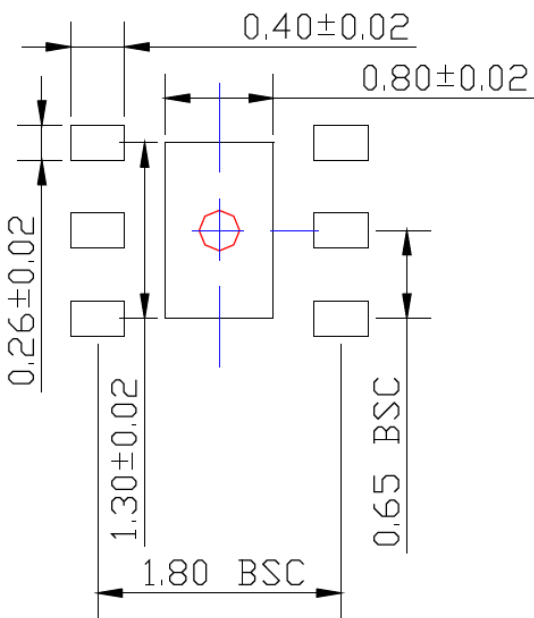
POD-Land Pattern drawing # DFN22-6LD-PL-1

## RECOMMENDED LAND PATTERN

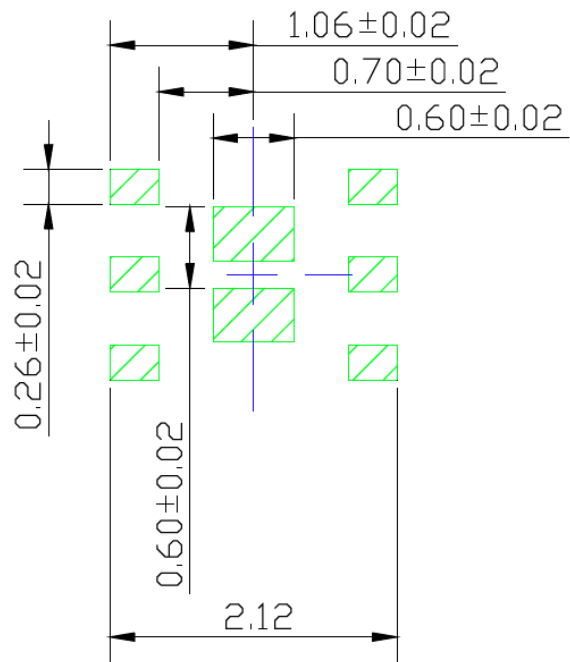
NOTE: 4,5



STACKED-UP



EXPOSED METAL TRACE



SOLDER STENCIL OPENING

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>.

## **APPENDIX A: REVISION HISTORY**

### **Revision A (October 2017)**

- Converted Micrel document MIC5319 to Microchip data sheet DS20005876A.
- Minor text changes throughout.

### **Revision B (February 2018)**

- Replaced the incorrect DFN 2x2 package drawing with the correct version.

# MIC5319

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NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

<u>PART NO.</u>	<u>-X.X</u>	<u>X</u>	<u>XX</u>	<u>-XX</u>
Device	Output Voltage	Junction Temp. Range	Package	Media Type
<b>Device:</b>	MIC5319:	500 mA $\mu$ Cap Ultra-Low Dropout High PSRR LDO Regulator		
<b>Voltage:</b>	<blank>= Adjustable 1.3H = 1.375V 1.8 = 1.8V 1.85 = 1.85V 2.5 = 2.5V 2.6 = 2.6V 2.7 = 2.7V 2.8 = 2.8V 2.85 = 2.85V (DFN Only) 2.9 = 2.9V (DFN Only) 3.0 = 3.0V 3.3 = 3.3V 5.0 = 5.0V			
<b>Junction Temperature Range:</b>	Y =	-40°C to +125°C RoHS-Compliant		
<b>Package:</b>	D5 =	5-Lead TSOT23		
	ML =	6-Lead 2 mm x 2 mm DFN		
<b>Media Type:</b>	TX =	3,000/Reel (with reversed Pin 1; D5 only)		
	TR =	3,000/Reel (D5)		
	TR =	5,000/Reel (ML)		
<b>Examples:</b>				
a) MIC5319-1.3HYML-TR: 500 mA $\mu$ Cap Ultra-Low Dropout High PSRR LDO Regulator, 1.375V Output Voltage, -40°C to +125°C, 6-Lead DFN, 5,000/Reel				
b) MIC5319YD5-TX: 500 mA $\mu$ Cap Ultra-Low Dropout High PSRR LDO Regulator, Adjustable Output Voltage, -40°C to +125°C, 5-Lead TSOT23, 3,000/Reel w/ Reversed Pin 1				
c) MIC5319-2.7YML-TR: 500 mA $\mu$ Cap Ultra-Low Dropout High PSRR LDO Regulator, 2.7V Output Voltage, -40°C to +125°C, 6-Lead DFN, 5,000/Reel				
d) MIC5319-3.0YD5-TR: 500 mA $\mu$ Cap Ultra-Low Dropout High PSRR LDO Regulator, 3.0V Output Voltage, -40°C to +125°C, 5-Lead TSOT23, 3,000/Reel				
e) MIC5319-2.85YML-TR: 500 mA $\mu$ Cap Ultra-Low Dropout High PSRR LDO Regulator, 2.85V Output Voltage, -40°C to +125°C, 6-Lead DFN, 5,000/Reel				
f) MIC5319-5.0YD5-TX: 500 mA $\mu$ Cap Ultra-Low Dropout High PSRR LDO Regulator, 5.0V Output Voltage, -40°C to +125°C, 5-Lead TSOT23, 3,000/Reel w/ Reversed Pin 1				
<b>Note 1:</b> Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.				

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NOTES:

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- Microchip is willing to work with the customer who is concerned about the integrity of their code.
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